

### **PCD3350A**

Ceibo In-Circuit Emulator Supporting PCD3350A: DS-48

http://ceibo.com/eng/products/ds48.shtml

Ceibo Programmer Supporting PCD3350A: MP-51

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### INTEGRATED CIRCUITS

## DATA SHEET

### **PCD3350A**

8-bit microcontroller with DTMF generator, 256 bytes EEPROM and real-time clock

Product specification Supersedes data of 1996 May 09 File under Integrated Circuits, IC03 1996 Dec 18





# 8-bit microcontroller with DTMF generator, 256 bytes EEPROM and real-time clock

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## 8-bit microcontroller with DTMF generator, 256 bytes EEPROM and real-time clock

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#### 1 FEATURES

- 8-bit CPU, ROM, RAM, EEPROM, real-time clock and I/O; all in a 44-lead quad flat package
- 8 kbytes ROM
- 256 bytes RAM
- 256 bytes Electrically Erasable Programmable Read Only Memory (EEPROM)
- 32 kHz crystal oscillator for Real-Time Clock (RTC)
- EEPROM programmable RTC
- Over 100 instructions (based on MAB8048) all of 1 or 2 cycles
- 34 quasi-bidirectional I/O port lines
- 8-bit programmable Timer/event counter 1
- 8-bit reloadable Timer 2
- Three single-level vectored interrupts:
  - external
  - 8-bit programmable Timer/event counter 1
  - derivative; triggered by reloadable Timer 2
- Two test inputs, one of which also serves as the external interrupt input
- DTMF, modem, musical tone generator
- Reference for supply and temperature-independent tone output
- Filtering for low output distortion (CEPT compatible)
- · Melody output for ringer application
- Programmable DTMF clock divider
- Power-on-reset
- · Stop and Idle modes

- Supply voltage: 1.8 to 6 V (DTMF tone output and EEPROM erase/write from 2.5 V)
- CPU clock frequency: 1 to 16 MHz (3.58 MHz or 10.74 MHz for DTMF)
- Operating ambient temperature: -25 to +70 °C
- Manufactured in silicon gate CMOS process.

### 2 GENERAL DESCRIPTION

This data sheet details the specific properties of the PCD3350A. The shared properties of the PCD33xxA family of microcontrollers are described in the "PCD33xxA family" data sheet, which should be read in conjunction with this publication.

The PCD3350A is a microcontroller designed primarily for telephony applications. It includes 8 kbytes ROM, 256 bytes RAM, 34 I/O lines, and an on-chip generator for dual tone multifrequency (DTMF), modem and musical tones. In addition to dialling, the generated frequencies can be made available as square waves for melody generation, providing ringer operation.

The PCD3350A also incorporates 256 bytes of EEPROM, permitting data storage without battery backup. The EEPROM can be used for storing telephone numbers, particularly for implementing redial functions.

Finally, the PCD3350A includes a low power 32 kHz crystal oscillator with an EEPROM programmable Real-Time Clock (RTC) working in standby mode.

The instruction set is similar to that of the MAB8048 and is a sub-set of that listed in the "PCD33xxA family" data sheet.

### 3 ORDERING INFORMATION (see note 1)

TYPE NUMBER		PACKAGE				
I TPE NOWIDER	NAME	DESCRIPTION	VERSION			
PCD3350AH	QFP44	plastic quad flat package; 44 leads (lead length 2.35 mm); body $14 \times 14 \times 2.2$ mm	SOT205-1			

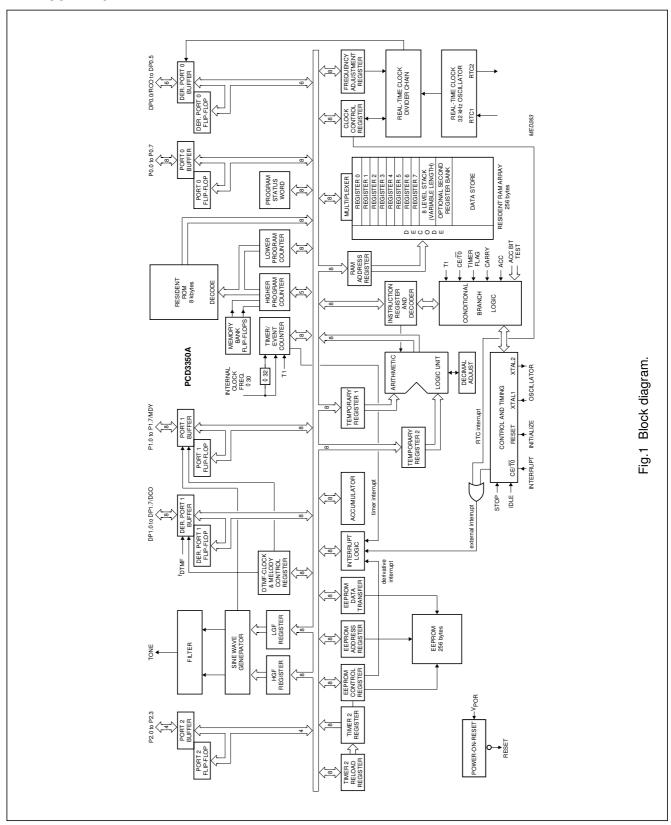
### Note

1. Please refer to the Order Entry Form (OEF) for this device for the full type number to use when ordering. This type number will also specify the required program and the ROM mask options.

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### 4 BLOCK DIAGRAM

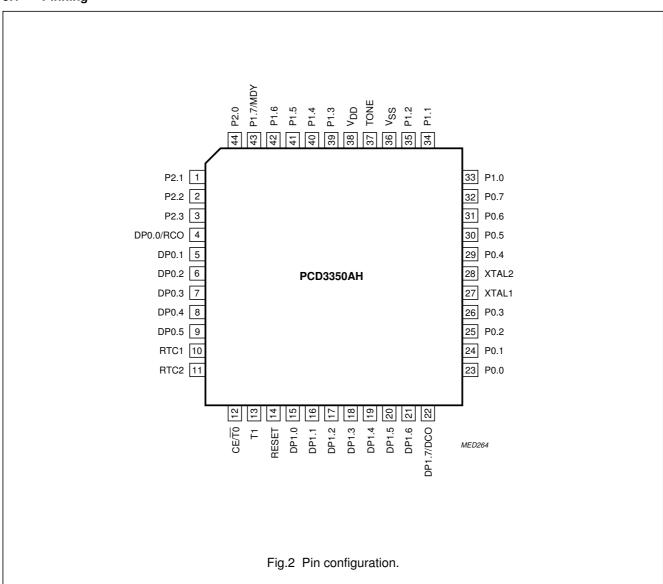


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### **5 PINNING INFORMATION**

### 5.1 Pinning



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### 5.2 Pin description

 Table 1
 SOT205-1 package (for information on parallel I/O ports, see Chapter 14)

SYMBOL	PIN	TYPE	DESCRIPTION
P2.1 to P2.3	1 to 3	I/O	3 bits of Port 2: 4-bit quasi-bidirectional I/O port
DP0.0/RCO	4	I/O	1 bit of Derivative Port 0: 6-bit quasi-bidirectional I/O port; or RTC output
DP0.1 to DP0.5	5 to 9	I/O	5 bits of Derivative Port 0: 6-bit quasi-bidirectional I/O port
RTC1	10	ı	Real Time Clock 32 kHz oscillator input
RTC2	11	0	Real Time Clock 32 kHz oscillator output
CE/TO	12	I	Chip Enable or Test 0 input
T1	13	I	Test 1/count input of 8-bit Timer/event counter 1
RESET	14	I	reset input
DP1.0 to DP1.6	15 to 21	I/O	7 bits of Derivative Port 1: 8-bit quasi-bidirectional I/O port
DP1.7/DCO	22	I/O	1 bit of Derivative Port 1: 8-bit quasi-bidirectional I/O port; or DTMF clock output
P0.0 to P0.3	23 to 26	I/O	4 bits of Port 0: 8-bit quasi-bidirectional I/O port
XTAL1	27	I	crystal oscillator/external clock input
XTAL2	28	0	crystal oscillator output
P0.4 to P0.7	29 to 32	I/O	4 bits of Port 0: 8-bit quasi-bidirectional I/O port
P1.0 to P1.2	33 to 35	I/O	3 bits of Port 1: 8-bit quasi-bidirectional I/O port
$V_{SS}$	36	Р	ground
TONE	37	0	DTMF output
$V_{DD}$	38	Р	positive supply voltage
P1.3 to P1.6	39 to 42	I/O	4 bits of Port 1: 8-bit quasi-bidirectional I/O port
P1.7/MDY	43	I/O	1 bit of Port 1: 8-bit quasi-bidirectional I/O port; or melody output
P2.0	44	I/O	1 bit of Port 2: 4-bit quasi-bidirectional I/O port

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#### **6 FREQUENCY GENERATOR**

A versatile frequency generator section with built-in programmable clock divider is provided (see Fig.3). The clock divider allows the DTMF section to run either with the main clock frequency ( $f_{DTMF} = f_{xtal}$ ) or with a third of it ( $f_{DTMF} = \frac{1}{3} \times f_{xtal}$ ) depending on the state of the divider control bit DIV3 (see Table 4). The frequency generator includes precision circuitry for dual tone multifrequency (DTMF) signals, which is typically used for tone dialling telephone sets.

The TONE output can alternatively issue twelve modem frequencies for data rates between 300 and 1200 bits/s.

In addition to DTMF and modem frequencies, two octaves of musical scale in steps of semitones are available. Their frequencies are provided either in purely sinusoidal form on the TONE output or as a square wave on the port line P1.7/MDY. The latter is typically for ringer applications in telephone sets. If no frequency output is selected the TONE output is in 3-state mode.

### 6.1 Frequency generator derivative registers

### 6.1.1 HIGH AND LOW GROUP FREQUENCY REGISTERS

Table 2 gives the addresses, symbols and access types of the High Group Frequency (HGF) and Low Group Frequency (LGF) registers, used to set the frequency output.

Table 2 Hexadecimal addresses, symbols, access types and bit symbols of the frequency registers

REGISTER	ACCESS				BIT SY	MBOLS										
ADDRESS	SYMBOL	TYPE	7	6	5	4	3	2	1	0						
11H	HGF	W	H7	H6	H5	H4	НЗ	H2	H1	H0						
12H	LGF	W	L7	L6	L5	L4	L3	L2	L1	L0						

### 6.1.2 CLOCK AND MELODY CONTROL REGISTER (MDYCON)

Table 3 Clock and Melody Control Register, MDYCON (address 13H; access type R/W)

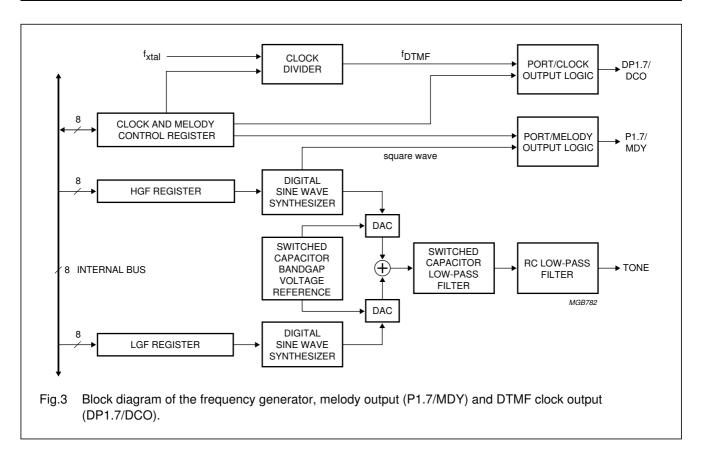
7	6	5	4	3	2	1	0
0	0	0	0	0	EDCO	DIV3	EMO

Table 4 Description of MDYCON bits

BIT	SYMBOL	DESCRIPTION
7 to 3	_	These bits are set to a logic 0.
2	EDCO	Enable DTMF clock output. If bit EDCO = 0, then DP1.7/DCO is a general purpose derivative port line. If bit EDCO = 1, then DP1.7/DCO is the DTMF clock output. EDCO = 1 does not inhibit the port instructions for DP1.7/DCO. Therefore the state of both port line and flip-flop may be read in and the port flip-flop may be written by derivative port instructions. However, the port flip-flop of DP1.7/DCO must remain set to avoid conflicts between DTMF clock and port outputs.
1	DIV3	Enable DTMF clock divider. If bit DIV3 = 0, then the DTMF clock $f_{DTMF} = f_{xtal}$ . If bit DIV3 = 1, then $f_{DTMF} = \frac{1}{3} \times f_{xtal}$ .
0	EMO	Enable Melody Output. If bit EMO = 0, then P1.7/MDY is a standard port line. If bit EMO = 1, then P1.7/MDY is the melody output. EMO = 1 does not inhibit the port instructions for P1.7/MDY. Therefore the state of both port line and flip-flop may be read in and the port flip-flop may be written by port instructions. However, the port flip-flop of P1.7/MDY must remain set to avoid conflicts between melody and port outputs. When the HGF contents are zero while EMO = 1, P1.7/MDY is in the HIGH state.

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### 6.2 Melody output (P1.7/MDY)

The melody output (P1.7/MDY) is very useful for generating musical notes when a purely sinusoidal signal is not required, such as for ringer applications.

The square wave (duty cycle =  $^{12}/_{23}$  or 52%) will include the attenuated harmonics of the base frequency, which is defined by the contents of the HGF register (Table 2). However, even higher frequency notes may be produced since the low-pass filtering on the TONE output is not applied to the P1.7/MDY output. This results in the minimum decimal value x in the HGF register (see equation in Section 6.4) being 2 for the P1.7/MDY output, rather than 60 for the TONE output. A sinusoidal TONE output is produced at the same time as the melody square wave, but due to the filtering, the higher frequency sine waves produced when x < 60 will not appear at the TONE output.

Since the melody output is shared with P1.7, the port flip-flop of P1.7 has to be set HIGH before using the melody output. This is to avoid conflicts between melody and port outputs. The melody output drive depends on the configuration of port P1.7/MDY, see Chapter 14, Table 27.

### 6.3 DTMF clock divider and output (DP1.7/DCO)

The DTMF clock divider allows the DTMF part to run either with the main clock frequency ( $f_{DTMF} = f_{xtal}$ ) or with a third of it ( $f_{DTMF} = \frac{1}{3} \times f_{xtal}$ ) depending on the state of the divider control bit DIV3 in register MDYCON.

For low power applications, a 3.58 MHz quartz crystal or PXE resonator can be chosen together with the divide-by-one function of the clock divider.

For other applications a 10.74 MHz quartz crystal or PXE resonator may be chosen together with the divide-by-three function of the clock divider. This triples the program speed of the microcontroller, thereby keeping the assumed DTMF frequency of 3.58 MHz.

Since a 3.58 MHz clock is needed for peripheral telephony circuits such as the analog voice scrambler/descrambler PCD4440T, a switchable DTMF clock output is provided depending on the state of the enable clock output bit EDCO in register MDYCON.

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If EDCO = 1 and DIV3 = 1 in the MDYCON register: a square wave with the frequency  $f_{DTMF} = \frac{1}{3} \times f_{xtal}$  is output on the derivative port line DP1.7/DCO. If EDCO = 1 and DIV3 = 0: a square wave with the frequency  $f_{DTMF} = f_{xtal}$  is output on the derivative port line DP1.7/DCO.

The melody output drive depends on the configuration of port P1.7/MDY, see Chapter 14, Table 27.

#### 6.4 Frequency registers

The two frequency registers HGF and LGF define two frequencies. From these, the digital sine synthesizers together with the Digital-to-Analog Converters (DACs) construct two sine waves. Their amplitudes are precisely scaled according to the bandgap voltage reference. This ensures tone output levels independent of supply voltage and temperature. The amplitude of the Low Group Frequency sine wave is attenuated by 2 dB compared to the amplitude of the High Group Frequency sine wave.

The two sine waves are summed and then filtered by an on-chip switched capacitor and RC low-pass filters. These guarantee that all DTMF tones generated fulfil the CEPT recommendations with respect to amplitude, frequency deviation, total harmonic distortion and suppression of unwanted frequency components.

The value 00H in a frequency register stops the corresponding digital sine synthesizer. If both frequency registers contain 00H, the whole frequency generator is shut off, resulting in lower power consumption.

The frequency 'f' of the sine wave generated from either of the frequency registers is a function of the clock frequency 'f<sub>xtal</sub>' and the decimal value 'x' held in the register. The equation relating these variables is:

$$f = \frac{f_{xtal}}{[23(x+2)]}$$
; where  $60 \le x \le 255$ .

The frequency limitation given by  $x \ge 60$  is due to the low-pass filters which would attenuate higher frequency sine waves.

### 6.5 DTMF frequencies

Assuming an oscillator frequency  $f_{xtal} = 3.58$  MHz, the DTMF standard frequencies can be implemented as shown in Table 5.

The relationships between telephone keyboard symbols, DTMF frequency pairs and the frequency register contents are given in Table 6.

**Table 5** DTMF standard frequencies and their implementation; value = LGF, HGF contents

VALUE	FREQUE	DEVIATION		
(HEX)	STANDARD	(%)	(Hz)	
DD	697	697.90	0.13	0.90
C8	770	770.46	0.06	0.46
B5	852	850.45	-0.18	-1.55
А3	941	943.23	0.24	2.23
7F	1209	1206.45	-0.21	-2.55
72	1336	1341.66	0.42	5.66
67	1 477	1482.21	0.35	5.21
5D	1633	1638.24	0.32	5.24

**Table 6** Dialling symbols, corresponding DTMF frequency pairs and frequency register contents

TEL EDUONE	TELEPHONE PINE EREO LOE LIGE								
TELEPHONE KEYBOARD SYMBOLS	DTMF FREQ. PAIRS (Hz)	LGF VALUE (HEX)	HGF VALUE (HEX)						
0	(941, 1336)	А3	72						
1	(697, 1209)	DD	7F						
2	(697, 1336)	DD	72						
3	(697, 1477)	DD	67						
4	(770, 1209)	C8	7F						
5	(770, 1336)	C8	72						
6	(770, 1477)	C8	67						
7	(852, 1209)	B5	7F						
8	(852, 1336)	B5	72						
9	(852, 1477)	B5	67						
Α	(697, 1633)	DD	5D						
В	(770, 1633)	C8	5D						
С	(852, 1633)	B5	5D						
D	(941, 1633)	A3	5D						
•	(941, 1209)	A3	7F						
#	(941, 1477)	A3	67						

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### 6.6 Modem frequencies

Again assuming an oscillator frequency  $f_{xtal} = 3.58$  MHz, the standard modem frequencies can be implemented as in Table 7. It is suggested to define the frequency by the HGF register while the LGF register contains 00H, disabling Low Group Frequency generation.

**Table 7** Standard modem frequencies and their implementation

F							
FREQUE	DEVIATION						
MODEM	GENERATED	(%)	(Hz)				
980 <sup>(1)</sup>	978.82	-0.12	-1.18				
1180 <sup>(1)</sup>	1179.03	-0.08	-0.97				
1070 <sup>(2)</sup>	1073.33	0.31	3.33				
1270 <sup>(2)</sup>	1265.30	-0.37	-4.70				
1200 <sup>(3)</sup>	1197.17	-0.24	-2.83				
2200 <sup>(3)</sup>	2192.01	-0.36	-7.99				
1300(4)	1296.94	-0.24	-3.06				
2100 <sup>(4)</sup>	2103.14	0.15	3.14				
1650 <sup>(1)</sup>	1655.66	0.34	5.66				
1850 <sup>(1)</sup>	1852.77	0.15	2.77				
2025(2)	2021.20	-0.19	-3.80				
2225 <sup>(2)</sup>	2223.32	-0.08	-1.68				
	MODEM  980 <sup>(1)</sup> 1180 <sup>(1)</sup> 1070 <sup>(2)</sup> 1270 <sup>(2)</sup> 1200 <sup>(3)</sup> 2200 <sup>(3)</sup> 1300 <sup>(4)</sup> 2100 <sup>(4)</sup> 1650 <sup>(1)</sup> 1850 <sup>(1)</sup> 2025 <sup>(2)</sup>	980 <sup>(1)</sup> 978.82 1180 <sup>(1)</sup> 1179.03 1070 <sup>(2)</sup> 1073.33 1270 <sup>(2)</sup> 1265.30 1200 <sup>(3)</sup> 1197.17 2200 <sup>(3)</sup> 2192.01 1300 <sup>(4)</sup> 1296.94 2100 <sup>(4)</sup> 2103.14 1650 <sup>(1)</sup> 1655.66 1850 <sup>(1)</sup> 1852.77 2025 <sup>(2)</sup> 2021.20	MODEM         GENERATED         (%)           980(1)         978.82         -0.12           1180(1)         1179.03         -0.08           1070(2)         1073.33         0.31           1270(2)         1265.30         -0.37           1200(3)         1197.17         -0.24           2200(3)         2192.01         -0.36           1300(4)         1296.94         -0.24           2100(4)         2103.14         0.15           1650(1)         1655.66         0.34           1850(1)         1852.77         0.15           2025(2)         2021.20         -0.19				

### Notes

- 1. Standard is V.21.
- 2. Standard is Bell 103.
- 3. Standard is Bell 202.
- 4. Standard is V.23.

### 6.7 Musical scale frequencies

Finally, two octaves of musical scale in steps of semitones can be realized, again assuming an oscillator frequency  $f_{xtal} = 3.58$  MHz (Table 8). It is suggested to define the frequency by the HGF register while the LGF contains 00H, disabling Low Group Frequency generation.

**Table 8** Musical scale frequencies and their implementation

	HGF	FREQUENCY (Hz)				
NOTE	VALUE (HEX)	STANDARD(1)	GENERATED			
D#5	F8	622.3	622.5			
E5	EA	659.3	659.5			
F5	DD	698.5	697.9			
F#5	D0	740.0	741.1			
G5	C5	784.0	782.1			
G#5	B9	830.6	832.3			
A5	AF	880.0	879.3			
A#5	A5	923.3	931.9			
B5	9C	987.8	985.0			
C6	93	1046.5	1044.5			
C#6	8A	1108.7	1111.7			
D6	82	1174.7	1179.0			
D#6	7B	1244.5	1245.1			
E6	74	1318.5	1318.9			
F6	6D	1396.9	1402.1			
F#6	67	1480.0	1482.2			
G6	61	1568.0	1572.0			
G#6	5C	1661.2	1 655.7			
A6	56	1760.0	1768.5			
A#6	51	1864.7	1875.1			
B6	4D	1975.5	1970.0			
C7	48	2093.0	2103.3			
C#7	44	2217.5	2223.3			
D7	40	2349.3	2358.1			
D#7	3D	2489.0	2470.4			

### Note

1. Standard scale based on A4 @ 440 Hz.

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#### 7 EEPROM AND TIMER 2 ORGANIZATION

The PCD3350A has 256 bytes of Electrically Erasable Programmable Read Only Memory (EEPROM). Such non-volatile storage provides data retention without the need for battery backup. In telecom applications, the EEPROM is used for storing redial numbers and for short dialling of frequently used numbers. More generally, EEPROM may be used for customizing microcontrollers, such as to include a PIN code or a country code, to define trimming parameters, to select application features from the range stored in ROM.

The most significant difference between a RAM and an EEPROM is that a bit in EEPROM, once written to a logic 1, cannot be cleared by a subsequent write operation. Successive write accesses actually perform a logical OR with the previously stored information. Therefore, to clear a bit, the whole byte must be erased and re-written with the particular bit cleared. Thus, an erase-and-write operation is the EEPROM equivalent of a RAM write operation.

Whereas read access times to an EEPROM are comparable to RAM access times, write and erase access times are much slower at 5 ms each. To make these operations more efficient, several provisions are available in the PCD3350A.

First, the EEPROM array is structured into 64 four-byte pages (see Fig.4) permitting access to 4 bytes in parallel (write page, erase/write page and erase page). It is also possible to erase and write individual bytes.

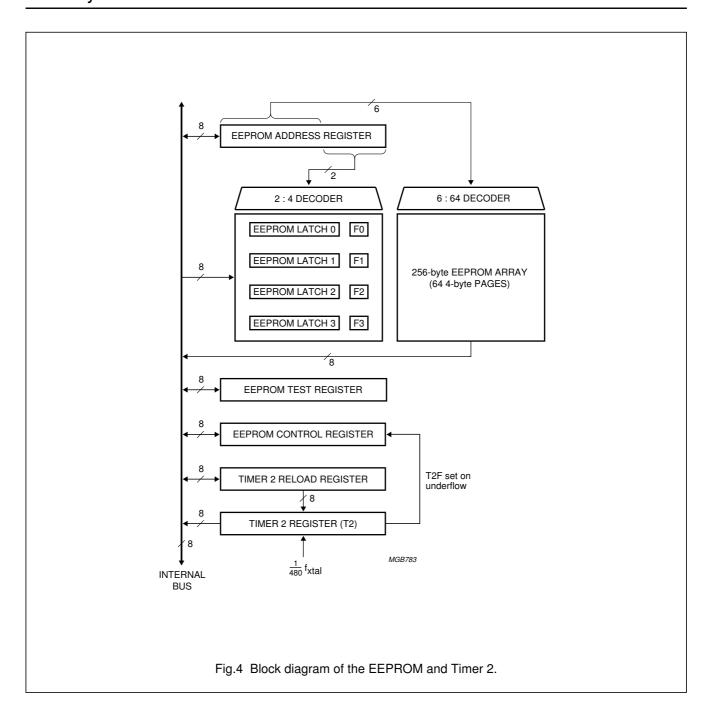
Finally, the EEPROM address register provides auto-incrementing, allowing very efficient read and write accesses to sequential bytes.

To simplify the erase and write timing, the derivative 8-bit down-counter (Timer 2) with reload register is provided. In addition to EEPROM timing, Timer 2 can be used for general real-time tasks, such as for measuring signal duration and for defining pulse widths.

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### 7.1 EEPROM registers

### 7.1.1 EEPROM CONTROL REGISTER (EPCR)

The behaviour of the EEPROM and Timer 2 section is defined by the EEPROM Control Register, as detailed in Tables 9, 10 and 11.

Table 9 EEPROM Control Register, EPCR (address 04H, access type R/W)

7	6	5	4	3	2	1	0
STT2	ET2I	T2F	EWP	MC3	MC2	MC1	0

Table 10 Description of EPCR bits

BIT	SYMBOL	DESCRIPTION
7	STT2	Start T2. If STT2 = 0, then Timer 2 is stopped; T2 value held. If STT2 = 1, then T2 decrements from reload value.
6	ET2I	Enable T2 interrupt. If ET2I = 0, then T2F event cannot request interrupt. If ET2I = 1, then T2F event can request interrupt.
5	T2F	Timer 2 flag. Set when T2 underflows (or by program); reset by program.
4	EWP	Erase or write in progress (EWP). Set by program (EWP starts EEPROM erase and/or write and Timer 2). Reset at the end of EEPROM erase and/or write.
3	MC3	Mode control 3 to 1. These three bits in conjunction with bit EWP select the mode as
2	MC2	shown in Table 11.
1	MC1	
0	_	This bit is set to a logic 0.

**Table 11** Mode selection; X = don't care

EWP	МСЗ	MC2	MC1	DESCRIPTION
0	0	0	0	read byte
0	0	1	0	increment mode
1	0	1	Х	write page
1	1	0	0	erase/write page
1	1	1	1	erase page
Х	0	0	1	not allowed
Х	1	0	1	
Х	1	1	0	

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### 7.1.2 EEPROM ADDRESS REGISTER (ADDR)

The EEPROM Address Register (ADDR) determines the EEPROM location to which an EEPROM access is directed.

As a whole, ADDR auto-increments after read and write cycles to EEPROM, but remains fixed after erase cycles. This behaviour generates the correct ADDR contents for sequential read accesses and for sequential write or erase/write accesses with intermediate page setup. Overflow of the 8-bit counter wraps around to zero. See Tables 12 and 13.

Table 12 EEPROM Address Register, ADDR (address 01H, access type R/W)

7	6	5	4	3	2	1	0
AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0

### Table 13 Description of ADDR bits

BIT	SYMBOL	DESCRIPTION
7 to 2	AD7 to AD2	AD7 to AD2 select one of 64 pages.
1 to 0	AD1 to AD0	AD1 and AD0 are irrelevant during erase and write cycles. For read accesses, AD0 and AD1 indicate the byte location within an EEPROM page. During page setup, finally, AD0 and AD1 select EEPROM Latch 0 to 3 whereas AD2 to AD6 are irrelevant. If increment mode (see Table 11) is active during page setup, the subcounter consisting of AD0 and AD1 increments after every write to an EEPROM latch, thus enhancing access to sequential EEPROM latches. Incrementing stops when EEPROM Latch 3 is reached, i.e. when AD0 and AD1 are both a logic 1.

### 7.1.3 EEPROM DATA REGISTER (DATR)

### Table 14 EEPROM Data Register, DATR (address 03H; access type R/W)

7	6	5	4	3	2	1	0
D7	D6	D5	D4	D3	D2	D1	D0

### Table 15 Description of DATR bits

BIT	SYMBOL	DESCRIPTION
7 to 0	D7 to D0	The EEPROM Data Register (DATR) is only a conceptual entity. A read operation from DATR, reads out the EEPROM byte addressed by ADDR. On the other hand, a write operation to DATR, loads data into the EEPROM latch (see Fig.4) defined by bits AD0 and AD1 of ADDR.

### 7.1.4 EEPROM TEST REGISTER (TST)

The EEPROM Test Register is used for testing purposes during device manufacture. It must not be accessed by the device user.

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#### 7.2 EEPROM latches

The four EEPROM latches (EEPROM Latch 0 to 3; Fig.4) cannot be read by user software. Due to their construction, the latches can only be preset, but not cleared. Successive write operations through DATR to the EEPROM latches actually perform a logical OR with the previously stored data in EEPROM. The EEPROM latches are reset at the conclusion of any EEPROM cycle.

### 7.3 EEPROM flags

The four EEPROM flags (F0 to F3; Fig.4) cannot be directly accessed by user software. An EEPROM flag is set as a side-effect when the corresponding EEPROM latch is written through DATR. The EEPROM flags are reset at the conclusion of any EEPROM cycle.

#### 7.4 EEPROM macros

The instruction sequence used in an EEPROM access should be treated as an indivisible entity. Erroneous programs result if ADDR, DATR, RELR or EPCR are inadvertently changed during an EEPROM cycle or its setup. Special care should be taken if the program may asynchronously divert due to an interrupt. A new access to the EEPROM may only be initiated when no write, erase or erase/write cycles are in progress. This can be verified by reading bit EWP (register EPCR).

For write, erase and erase/write cycles, it is assumed that the Timer 2 Reload Register (RELR) has been loaded with the appropriate value for a 5 ms delay, which depends on  $f_{xtal}$  (see Table 22). The end of a write, erase or erase/write cycle will be signalled by a cleared EWP and by a Timer 2 interrupt provided that ET2I = 1 and that the derivative interrupt is enabled.

### 7.5 EEPROM access

One read, one write, one erase/write and one erase access are defined by bits EWP and MC1 to MC3 in the EPCR register; see Table 9.

**Read byte** retrieves the EEPROM byte addressed by ADDR when DATR is read. Read cycles are instantaneous.

Write and erase cycles take 5 ms, however. Erase/write is a combination of an erase and a subsequent write cycle, consequently taking 10 ms.

As their names imply, write page, erase page and erase/write page are applied to a whole EEPROM page. Therefore, bits AD0 and AD1 of register ADDR (see Table 12), defining the byte location within an EEPROM

page, are irrelevant during write and erase cycles. However, write and erase cycles need not affect all bytes of the page. The EEPROM flags F0 to F3 (see Fig.4) determine which bytes within the EEPROM page are affected by the erase and/or write cycles. A byte whose corresponding EEPROM flag is zero remains unchanged.

With erase page, a byte is erased if its corresponding EEPROM flag is set. With write page, data in EEPROM Latch 0 to 3 (Fig.4) are ORed to the individual page bytes if and only if the corresponding EEPROM flags are set.

In an erase/write cycle, F0 to F3 select which page bytes are erased and ORed with the corresponding EEPROM latches. ORing, in this case, means that the EEPROM latches are copied to the selected page bytes.

The described page-wise organization of erase and write cycles allows up to four bytes to be individually erased or written within 5 ms. This advantage necessitates a preparation step, called **page setup**, before the actual erase and/or write cycle can be executed.

Page setup controls EEPROM latches and EEPROM flags. This will be described in the Sections 7.5.1 to 7.5.5.

### 7.5.1 PAGE SETUP

Page setup is a preparation step required before write page, erase page and erase/write page cycles. As previously described, these page operations include single-byte write, erase and erase/write as a special case. EEPROM flags F0 to F3 determine which page bytes will be affected by the mentioned page operations. EEPROM Latch 0 to 3 must be preset through DATR to specify the write cycle data to EEPROM and to set the EEPROM flags as a side-effect.

Obviously, the actual preset value of the EEPROM latches is irrelevant for erase page. Preset of one, two, three or all four EEPROM latches and the corresponding EEPROM flags can be performed by repeatedly defining ADDR and writing to DATR (see Table 16).

If more than one EEPROM latch must be preset, the subcounter consisting of AD0 and AD1 can be induced to auto-increment after every write to DATR, thus stepping through all EEPROM latches. For this purpose, increment mode (Table 11) must be selected. Auto-incrementing stops at EEPROM Latch 3. It is not mandatory to start at EEPROM Latch 0 as in shown in Table 17.

Note that AD2 to AD7 are irrelevant during page setup. They will usually specify the intended EEPROM page, anticipating the subsequent page cycle.

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From now on, it will be assumed that AD2 to AD7 will contain the intended EEPROM page address after page setup.

Table 16 Page setup; preset

INSTRUCTION	RESULT
MOV A, #addr	address of EEPROM latch
MOV ADDR, A	send address to ADDR
MOV A, #data	load write, erase/write or erase data
MOV DATR, A	send data to addressed EEPROM latch

Table 17 Page setup; auto-incrementing

INSTRUCTION	RESULT
MOV A, #MC2	increment mode control word
MOV EPCR, A	select increment mode
MOV A, #baddr	EEPROM Latch 0 address (AD0 = AD1 = 0)
MOV ADDR, A	send EEPROM Latch 0 address to ADDR
MOV A, R0	load 1 <sup>st</sup> byte from Register 0
MOV DATR, A	send 1st byte to EEPROM Latch 0
MOV A, R1	load 2 <sup>nd</sup> byte from Register 1
MOV DATR, A	send 2 <sup>nd</sup> byte to EEPROM Latch 1
MOV A, R2	load 3 <sup>rd</sup> byte from Register 2
MOV DATR, A	send 3 <sup>rd</sup> byte to EEPROM Latch 2
MOV A, R3	load 4 <sup>th</sup> byte from Register 3
MOV DATR, A	send 4 <sup>th</sup> byte to EEPROM Latch 3

#### 7.5.2 READ BYTE

Since ADDR auto-increments after a read cycle regardless of the page boundary, successive bytes can efficiently be read by repeating the last instruction.

Table 18 Read byte

INSTRUCTION	RESULT	
MOV A, #RDADDR	load read address	
MOV ADDR, A	send address to ADDR	
MOV A, DATR	read EEPROM data	

#### 7.5.3 WRITE PAGE

The write cycle performs a logical OR between the data in the EEPROM latches and that in the addressed EEPROM page. To actually copy the data from the EEPROM latches, the corresponding bytes in the page should previously have been erased.

The EEPROM latches are preset as described in Section 7.5.1. The actual transfer to the EEPROM is then performed as shown in Table 19.

The last instruction also starts Timer 2. The data in the EEPROM latches are ORed with that in the corresponding page bytes within 5 ms. A single-byte write is simply a special case of 'write page'.

ADDR auto-increments after the write cycle. If AD0 and AD1 addressed EEPROM Latch 3 prior to the write cycle, ADDR will point to the next EEPROM page (by bits AD2 to AD7) and to EEPROM Latch 0 (by bits AD0 and AD1). This allows efficient coding of multi-page write operations.

Table 19 Write page

INSTRUCTION	RESULT
MOV A, #EWP + MC2	'write page' control word
MOV EPCR, A	start 'write page' cycle

### 7.5.4 ERASE/WRITE PAGE

The EEPROM latches are preset as described in Section 7.5.1. The page bytes corresponding to the asserted flags (among F0 to F3) are erased and re-written with the contents of the respective EEPROM latches.

The last instruction also starts Timer 2. Erasure takes 5 ms upon which Timer Register T2 reloads for another 5 ms cycle for writing. The top cycles together take 10 ms. A single-byte erase/write is simply a special case of 'erase/write page'.

ADDR auto-increments after the write cycle. If AD0 and AD1 addressed EEPROM Latch 3 prior to the write cycle, ADDR will point to the next EEPROM page (by AD2 to AD7) and to EEPROM Latch 0 (by AD0 and AD1). This allows efficient coding of multi-page erase/write operations.

Table 20 Erase/write page

INSTRUCTION	RESULT
MOV A, #EWP + MC3	'erase/write page' control word
MOV EPCR, A	start 'erase/write page' cycle

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#### 7.5.5 ERASE PAGE

The EEPROM flags are set as described in Section 7.5.1. The corresponding page bytes are erased.

The last instruction also starts Timer 2. Erasure takes 5 ms. A single-byte erase is simply a special case of 'erase page'.

Note that ADDR does not auto-increment after an erase cycle.

Table 21 Erase page

INSTRUCTION	RESULT
MOV A, #EWP + MC3 + MC2 + MC1	'erase page' control word
MOV EPCR, A	start 'erase page' cycle

#### 7.6 Timer 2

Timer 2 is a 8-bit down-counter decremented at a rate of  $1_{480} \times f_{xtal}$ . It may be used either for EEPROM timing or as a general purpose timer. Conflicts between the two applications should be carefully avoided.

### 7.6.1 TIMER 2 FOR EEPROM TIMING

When used for EEPROM timing, Timer 2 serves to generate the 5 ms intervals needed for erasing or writing the EEPROM. At the decrement rate of  $^{1}/_{480} \times f_{xtal}$ , the reload value for a 5 ms interval is a function of  $f_{xtal}$ . Table 22 summarizes the required reload values for a number of oscillator frequencies.

Timer 2 is started by setting bit EWP in the EPCR. The Timer Register T2 is loaded with the reload value from RELR. T2 decrements to zero.

For an erase/write cycle, underflow of T2 indicates the end of the erase operation. Therefore, Timer Register T2 is reloaded from RELR for another 5 ms interval during which the flagged EEPROM latches are copied to the corresponding bytes in the page addressed by ADDR.

The second underflow of an erase/write cycle and the first underflow of write page and erase page conclude the corresponding EEPROM cycle. Timer 2 is stopped, T2F is set whereas EWP and MC1 to MC3 are cleared.

**Table 22** Reload values as a function of f<sub>xtal</sub>

f <sub>xtal</sub> (MHz)	RELOAD VALUE(1) (HEX)
1	0A
2	14
3.58	25
6	3E
10.74	6F
16	A6

### Note

1. The reload value is  $(5 \times 10^{-3} \times \frac{1}{480} \times f_{xtal}) - 1$ ;  $f_{xtal}$  in MHz.

### 7.6.2 TIMER 2 AS A GENERAL PURPOSE TIMER

When used for purposes other than EEPROM timing, Timer 2 is started by setting STT2. The Timer 2 Register T2 (see Table 28) is loaded with the reload value from RELR. T2 decrements to zero. On underflow, T2 is reloaded from RELR, T2F is set and T2 continues to decrement.

Timer 2 can be stopped at any time by clearing STT2. The value of T2 is then held and can be read out. After setting STT2 again, Timer 2 decrements from the reload value. Alternatively, it is possible to read T2 'on the fly' i.e. while Timer 2 is operating.

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#### 8 REAL-TIME CLOCK

The Real Time Clock (RTC) consists of a 32 kHz crystal oscillator, a 32 kHz to 1 second or 1 minute divider chain, an 8-bit Frequency Adjustment Register and the Clock Control Register. The complete RTC section works independently of the microcontroller status, even in Idle and Stop mode.

#### 8.1 Oscillator

The internal 32 kHz oscillator needs an external quartz crystal with a frequency of 32768.00 Hz (a positive deviation up to +259  $\times$  10 $^{-6}$  is allowed) and an external feedback resistor between pins RTC1 and RTC2; 4.7  $M\Omega$  is recommended. It is controlled by the RUN-bit in the Clock Control Register.

#### 8.2 Divider chain

The divider chain operates with the 32 kHz oscillator output and divides this signal down to two clocks with a period of 1 second or 1 minute. Depending on bit ITS in the Clock Control Register, the falling edge of the seconds or minutes clock is used to set the Clock Interrupt Flag (CIF) in the Clock Control Register.

Since the clock interrupt is used to let the microcontroller leave the Stop mode, it is ORed to the external interrupt (CE/ $\overline{T0}$ ) and has the same functionality, e.g. it must be enabled in the Clock Control Register (bit ECI) and by execution of the instruction 'EN I'. The clock interrupt will then be treated as an external interrupt.

Additionally, the divider chain generates a 16 kHz clock (RCO) that can be routed through derivative port line DP0.0/RCO, controlled by bit ERCO in the Clock Control Register.

### 8.3 Frequency adjustment

The frequency adjustment is used to extend the interrupt time by defining the number of 16 kHz clocks in the Frequency Adjustment Register that will be counted twice within the first second period after a minute interrupt.

If the second interrupt is used (ITS = 1), every  $60^{th}$  interval may be up to 15.3 ms longer than the others as a result of the frequency adjustment. The adjusted Minute Interrupt Time (MIT) now shows a maximum deviation of  $0.5 \times 10^{-6}$ .

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### 8.4 Real-time clock derivative registers

### 8.4.1 CLOCK CONTROL REGISTER (CLCR)

The register access type is R/W and the value at reset is 00H.

Table 23 Clock Control Register, CLCR (address 20H)

7	6	5	4	3	2	1	0
0	TST2	TST1	ERCO	RUN	ITS	CIF	ECI

Table 24 Description of CLCR bits

BIT	SYMBOL	DESCRIPTION
7	_	This bit is set to a logic 0.
6	TST2	Test 2 input. This is a testing bit; has to be fixed at a logic 0 by user software.
5	TST1	Test 1 input. This is a testing bit; has to be fixed at a logic 0 by user software.
4	ERCO	Enable 16 kHz clock output. If ERCO = 0, then the DP0.0/RCO is a derivative port line. If ERCO = 1, then DP0.0./RCO is a 16 kHz clock output. ERCO = 1 does not inhibit the port instructions for DP0.0/RCO. Therefore the state of both port line and flip-flop may be read in and the port flip-flop may be written by derivative port instructions. However, the port flip-flop of DP0.0/RCO must remain set to avoid conflicts between 16 kHz clock and port outputs.
3	RUN	Clock run or stop bit. If RUN = 0, then the oscillator is stopped and the clock is reset.  If RUN = 1, then the oscillator and the clock are running.
2	ITS	Interrupt Time Select. If ITS = 1, then the interrupt time is one second.  If ITS = 0, then the interrupt time is one minute.
1	CIF	Clock Interrupt Flag. Set by hardware, if RTC divider chain overflows (every second or minute depending on ITS) or by program. Reset by program.
0	ECI	Enable Clock Interrupt. If ECI = 0, then CIF event cannot request interrupt.  If ECI = 1, then CIF event requests interrupt.

### 8.4.2 Frequency Adjustment Register (FAR)

The frequency adjustment value of the RTC is defined by the 8-bit Frequency Adjustment Register. The register access type is R/W. The value of FAR at reset is 00H.

The significance of the individual bits of FAR can be illustrated by the following equation:

Minute Interrupt Time (MIT) = 
$$\left(60 \times 2^{\frac{14}{f_{RCO}}}\right) + \frac{FAR}{2^{14}}$$

where  $f_{RCO} = RTC$  frequency and 'FAR' is the decimal contents of the Frequency Adjustment Register.

Table 26 shows the recommended correction factor FAR for all allowed RTC frequencies f<sub>RCO</sub>.

Table 25 Frequency Adjustment Register, FAR (address 21H)

7	6	5	4	3	2	1	0
FAR7	FAR6	FAR5	FAR4	FAR3	FAR2	FAR1	FAR0

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Table 26 FAR as a result of f<sub>RCO</sub>

_	
f <sub>RCO</sub>	FAR (HEX)
16384.000	00
16384.018	01
16384.033	02
16384.051	03
16384.066	04
16384.084	05
16384.100	06
16384.117	07
16384.135	08
16384.150	09
16384.168	0A
16384.184	0B
16384.201	0C
16384.217	0D
16384.234	0E
16384.250	0F
16384.268	10
16384.283	11
16384.301	12
16384.316	13
16384.334	14
16384.350	15
16384.367	16
16384.385	17
16384.400	18
16384.418	19
16384.434	1A
16384.451	1B
16384.467	1C
16384.484	1D

f <sub>RCO</sub>	FAR (HEX)
16384.500	1E
16384.518	1F
16384.533	20
16384.551	21
16384.566	22
16384.584	23
16384.600	24
16384.617	25
16384.635	26
16384.650	27
16384.668	28
16384.684	29
16384.701	2A
16384.717	2B
16384.734	2C
16384.750	2D
16384.768	2E
16384.783	2F
16384.801	30
16384.816	31
16384.834	32
16384.850	33
16384.867	34
16384.885	35
16384.900	36
16384.918	37
16384.934	38
16384.951	39
16384.967	3A
16384.984	3B
16385.000	3C

f <sub>RCO</sub>	FAR (HEX)
16385.018	3D
16385.033	3E
16385.051	3F
16385.066	40
16385.084	41
16385.100	42
16385.117	43
16385.135	44
16385.150	45
16385.168	46
16385.184	47
16385.201	48
16385.217	49
16385.234	4A
16385.250	4B
16385.268	4C
16385.283	4D
16385.301	4E
16385.316	4F
16385.334	50
16385.350	51
16385.367	52
16385.385	53
16385.400	54
16385.418	55
16385.434	56
16385.451	57
16385.467	58
16385.484	59
16385.500	5A
16385.518	5B

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f <sub>RCO</sub>	FAR (HEX)
	1 1
16385.533	5C
16385.551	5D
16385.566	5E
16385.584	5F
16385.600	60
16385.617	61
16385.635	62
16385.650	63
16385.668	64
16385.684	65
16385.701	66
16385.717	67
16385.734	68
16385.750	69
16385.768	6A
16385.783	6B
16385.801	6C
16385.816	6D
16385.834	6E
16385.850	6F
16385.867	70
16385.885	71
16385.900	72
16385.918	73
16385.934	74
16385.951	75
16385.967	76
16385.984	77

f <sub>RCO</sub>	FAR (HEX)
16386.000	78
16386.018	79
16386.033	7A
16386.051	7B
16386.066	7C
16386.084	7D
16386.100	7E
16386.117	7F
16386.135	80
16386.150	81
16386.168	82
16386.184	83
16386.201	84
16386.217	85
16386.234	86
16386.250	87
16386.268	88
16386.283	89
16386.301	8A
16386.316	8B
16386.334	8C
16386.350	8D
16386.367	8E
16386.385	8F
16386.400	90
16386.418	91
16386.434	92
16386.451	93

f <sub>RCO</sub>	FAR (HEX)
16386.467	94
16386.484	95
16386.500	96
16386.518	97
16386.533	98
16386.551	99
16386.566	9A
16386.584	9B
16386.600	9C
16386.617	9D
16386.635	9E
16386.650	9F
16386.668	A0
16386.684	A1
16386.701	A2
16386.717	A3
16386.734	A4
16386.750	<b>A</b> 5
16386.768	A6
16386.783	A7
16386.801	A8
16386.816	A9
16386.834	AA
16386.850	AB
16386.867	AC
16386.885	AD
16386.900	AE
16386.918	AF

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f <sub>RCO</sub>	FAR (HEX)
16386.934	B0
16386.951	B1
16386.967	B2
16386.984	B3
16387.000	B4
16387.018	B5
16387.033	B6
16387.051	B7
16387.066	B8
16387.084	B9
16387.100	BA
16387.117	BB
16387.135	BC
16387.150	BD
16387.168	BE
16387.184	BF
16387.201	C0
16387.217	C1
16387.234	C2
16387.250	C3
16387.268	C4
16387.283	C5
16387.301	C6
16387.316	C7
16387.334	C8
16387.350	C9
16387.367	CA

f <sub>RCO</sub>	FAR (HEX)
16387.385	СВ
16387.400	CC
16387.418	CD
16387.434	CE
16387.451	CF
16387.467	D0
16387.484	D1
16387.500	D2
16387.518	D3
16387.533	D4
16387.551	D5
16387.566	D6
16387.584	D7
16387.600	D8
16387.617	D9
16387.635	DA
16387.650	DB
16387.668	DC
16387.684	DD
16387.701	DE
16387.717	DF
16387.734	E0
16387.750	E1
16387.768	E2
16387.783	E3
16387.801	E4
16387.816	E5

f <sub>RCO</sub>	FAR (HEX)
16387.834	E6
16387.850	E7
16387.867	E8
16387.885	E9
16387.900	EA
16387.918	EB
16387.934	EC
16387.951	ED
16387.967	EE
16387.984	EF
16388.002	F0
16388.018	F1
16388.035	F2
16388.051	F3
16388.068	F4
16388.084	F5
16388.102	F6
16388.117	F7
16388.135	F8
16388.152	F9
16388.168	FA
16388.186	FB
16388.201	FC
16388.219	FD
16388.234	FE
16384.000	FF

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#### 9 DERIVATIVE INTERRUPTS

One derivative interrupt event is defined. It is controlled by bits T2F and ET2I in the EPCR (see Tables 9 and 10).

The derivative interrupt event occurs when T2F is set. This request is honoured under the following circumstances:

- No interrupt routine proceeds
- No external interrupt request is pending
- The derivative interrupt is enabled
- · ET2l is set.

The derivative interrupt routine must include instructions that will remove the cause of the derivative interrupt by explicitly clearing T2F. If the derivative interrupt is not used, T2F may directly be tested by the program. Obviously, T2F can also be asserted under program control, e.g. to generate a software interrupt.

Although the clock interrupt is part of a derivative function it is linked to the external interrupt. A clock interrupt request is honoured under the following circumstances:

- No interrupt routine proceeds
- · No external interrupt request is pending
- The enable clock interrupt bit in the derivative clock control register is set.

### 10 TIMING

Although the PCD3350A operates over a clock frequency range from 1 to 16 MHz,  $f_{xtal} = 3.58$  MHz or 10.74 MHz will usually be chosen to take full advantage of the frequency generator (DTMF) section.

#### 11 RESET

In addition to the conditions given in the "PCD33xxA Family" data sheet, all derivative registers are cleared in the reset state.

#### 12 IDLE MODE

In Idle mode all derivative functions remain operative, i.e.:

- DTMF generator
- DTMF clock divider and output
- 32 kHz crystal oscillator and RTC
- · EEPROM and Timer 2 sections.

### 13 STOP MODE

Since the oscillator is switched off, the frequency generator, the EEPROM and the Timer 2 sections receive no clock. It is suggested to clear both the HGF and the LGF registers before entering Stop mode. This will cut off the biasing of the internal amplifiers, considerably reducing current requirements.

The Stop mode **must not** be entered while an erase and/or write access to EEPROM is in progress. The STOP instruction may only be executed when EWP in EPCR is zero. The Timer 2 section is frozen during Stop mode. After exit from Stop mode by a HIGH level on  $CE/\overline{T0}$ , Timer 2 proceeds from the held state.

The 32 kHz crystal oscillator and the RTC section remain operative during Stop mode (depending only on bit RUN in the Clock Control Register). In addition to the description in the "PCD33xxA Family" data sheet, Stop mode may be left by a clock interrupt event (see Chapter 9).

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### 14 SUMMARY OF I/O PORTS AND ROM MASK OPTIONS

All standard quasi-bidirectional I/O ports are available; see "PCD33xxA Family" data sheet.

- Port 0: 8 parallel port lines P0.0 to P0.7
- Port 1: 8 parallel port lines P1.0 to P1.7
- Port 2: 4 parallel port lines P2.0 to P2.3.

In addition to the standard ports, two derivative I/O ports are available:

- Derivative Port 0: 6 parallel port lines DP0.0 to DP0.5 (register DP0L)
- Derivative Port 1: 8 parallel port lines DP1.0 to DP1.7 (register DP1L).

The port options and the other ROM mask options are listed in Table 27. See Table 28 for the addresses of DP0L and DP1L.

Table 27 ROM mask options

FUNCTION IMPLEMENTED IN ROM OPTION						
Program/data	Any mix of instr 8 kbytes.	Any mix of instructions and data up to ROM size of 8 kbytes.				
Port Output						
P0.0 to P0.7	standard	open-drain	push-pull			
P1.0 to P1.6	standard	open-drain	push-pull			
P1.7/MDY; note 1	standard	open-drain	push-pull			
P2.0 to P2.3	standard	open-drain	push-pull			
DP0.0 to DP0.5	standard	open-drain	push-pull			
DP1.0 to DP1.6	standard	open-drain	push-pull			
DP1.7/DCO; note 2	standard	open-drain	push-pull			
Port State after reset						
P0.0 to P0.7	set	reset	_			
P1.0 to P1.6	set	reset	_			
P1.7/MDY	set	reset	_			
P2.0 to P2.3	set	reset	_			
DP0.0 to DP0.5	set	reset	_			
DP1.0 to DP1.6	set	reset	_			
DP1.7/DCO	set	reset	_			
Oscillator	,					
Transconductance	LOW (g <sub>mL</sub> )	MEDIUM (g <sub>mM</sub> )	HIGH (g <sub>mH</sub> )			
Power-on-reset						
Power-on-reset voltage level: V <sub>POR</sub>	1.2 to 3.6 V in i	1.2 to 3.6 V in increments of 100 mV; OFF				

#### **Notes**

- 1. If standard (Option 1) or push-pull (Option 3) output is chosen, the P1.7/MDY output becomes a push-pull output. If open-drain (Option 2) is chosen, the P1.7/MDY output becomes an open-drain output.
- 2. If standard (Option 1) or push-pull (Option 3) output is chosen, the DP1.7/DCO output becomes a push-pull output. If open-drain (Option 2) is chosen, the DP1.7/DCO output becomes an open-drain output.

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### 15 SUMMARY OF DERIVATIVE REGISTERS

Table 28 Register map

ADDR. (HEX)	REGISTER	7	6	5	4	3	2	1	0	R/W
00	not used	•								
01	EEPROM Address Register (ADDR)	0	AD6	AD5	AD4	AD3	AD2	AD1	AD0	R/W
02	not used									
03	EEPROM Data Register (DATR)	D7	D6	D5	D4	D3	D2	D1	D0	R/W
04	EEPROM Control Register (EPCR)	STT2	ET21	TF2	EWP	МС3	MC2	MC1	0	R/W
05	Timer 2 Reload Register (RELR)	R7	R6	R5	R4	R3	R2	R1	R0	R/W
06	Timer 2 Register (T2)	T2.7	T2.6	T2.5	T2.4	T2.3	T2.2	T2.1	T2.0	R
07	Test Register (TST) only for test purposes; not to be accessed by the device user						ser			
08 to 10	not used									
11	High Group Frequency Register (HGF)	H7	H6	H5	H4	НЗ	H2	H1	H0	W
12	Low Group Frequency Register (LGF)	L7	L6	L5	L4	L3	L2	L1	L0	W
13	Clock and Melody Control Register (MDYCON)	0	0	0	0	0	DCO	DIV3	EMO	R/W
14 to 1F	not used									
20	Clock Control Register (CLCR)	0	TST2	TST1	ERCO	RUN	ITS	CIF	ECI	R/W
21	Frequency Adjustment Register (FAR)	FAR7	FAR6	FAR5	FAR4	FAR3	FAR2	FAR1	FAR0	R/W
22 to 2F	not used									
30	Derivative Port 0 lines (DP0L)	0	0	D0.5	D0.4	D0.3	D0.2	D0.1	D0.0	R
31	Derivative Port 1 lines (DP1L)	D1.7	D1.6	D1.5	D1.4	D1.3	D1.2	D1.1	D1.0	R
32	Derivative Port 0 flip-flop (DP0FF)	0	0	F0.5	F0.4	F0.3	F0.2	F0.1	F0.0	R/W
33	Derivative Port 1 flip-flop (DP1FF)	F1.7	F1.6	F1.5	F1.4	F1.3	F1.2	F1.1	F1.0	R/W
34 to FF	not used									

### 16 HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However, it is good practice to take normal precautions appropriate to handling MOS devices (see "Data Handbook IC14, Section: Handling MOS devices").

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### 17 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
$V_{DD}$	supply voltage	-0.5	+7.0	V
VI	all input voltages	-0.5	$V_{DD} + 0.5$	V
I <sub>I</sub>	DC input current		+10	mA
I <sub>O</sub>	DC output current		+10	mA
P <sub>tot</sub>	total power dissipation		125	mW
Po	power dissipation per output		30	mW
I <sub>SS</sub>	ground supply current	-50	+50	mA
T <sub>stg</sub>	storage temperature	-65	+150	°C
Tj	operating junction temperature		90	°C

### **18 DC CHARACTERISTICS**

 $V_{DD}$  = 1.8 to 6 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = -25 to +70 °C; all voltages with respect to  $V_{SS}$ ;  $f_{xtal}$  = 3.58 MHz ( $g_{mL}$ );  $f_{RTC}$  = 32768 to 32768 + (32768  $\times$  200  $\times$  10<sup>-6</sup>) Hz; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply						
$V_{DD}$	supply voltage	see Fig.5				
	operating	note 1	1.8	_	6	V
	RAM data retention in Stop mode		1.0	_	6	V
I <sub>DD</sub>	operating supply current	see Figs 6 and 7; note 2				
		V <sub>DD</sub> = 3 V; value HGF or LGF ≠ 0	_	0.8	1.6	mA
		V <sub>DD</sub> = 3 V; value HGF = LGF = 0	_	0.35	0.7	mA
		$V_{DD} = 5 \text{ V}$ ; $f_{xtal} = 10.74 \text{ MHz } (g_{mM})$ ; value HGF or LGF $\neq$ 0; DIV3 = 1	_	2.7	6.2	mA
		$V_{DD} = 5 \text{ V}$ ; $f_{xtal} = 10.74 \text{ MHz } (g_{mM})$ ; value HGF = LGF = 0	_	1.7	4.2	mA
		$V_{DD} = 5 \text{ V}$ ; $f_{xtal} = 16 \text{ MHz } (g_{mH})$ ; value HGF = LGF = 0	_	3.5	_	mA

# 8-bit microcontroller with DTMF generator, 256 bytes EEPROM and real-time clock

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>DD(idle)</sub>	supply current (Idle mode)	see Figs 8 and 9; note 2				
		V <sub>DD</sub> = 3 V; value HGF or LGF ≠ 0	_	0.7	1.4	mA
		V <sub>DD</sub> = 3 V; value HGF = LGF =0	_	0.25	0.5	mA
		$V_{DD} = 5 \text{ V}; f_{xtal} = 10.74 \text{ MHz } (g_{mM});$ value HGF or LGF $\neq$ 0; DIV3 = 1	_	2.3	5.5	mA
		$V_{DD} = 5 \text{ V}; f_{xtal} = 10.74 \text{ MHz } (g_{mM});$ value HGF = LGF = 0	_	1.3	3.5	mA
		$V_{DD} = 5 \text{ V; } f_{xtal} = 16 \text{ MHz } (g_{mH});$ value HGF = LGF = 0	_	2.4	_	mA
I <sub>DD(stp)</sub>	supply current (Stop mode)	see Fig.10; notes 2 and 3				
		$V_{DD}$ = 1.8 V; $T_{amb}$ = 25 °C; RTC not running	_	1.0	5.5	μΑ
		$V_{DD} = 1.8 \text{ V;} T_{amb} = -25 \text{ to } +70 \text{ °C;}$ RTC not running	_	_	10	μΑ
		$V_{DD}$ = 1.8 V; $T_{amb}$ = 25 °C; RTC running	_	2.0	6.0	μΑ
Inputs						
V <sub>IL</sub>	LOW level input voltage		0	_	0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH level input voltage		0.7V <sub>DD</sub>	_	$V_{DD}$	V
I <sub>LI</sub>	input leakage current	$V_{SS} \le V_I \le V_{DD}$	-1	_	+1	μΑ
Port outp	uts			•		
I <sub>OL</sub>	LOW level output sink current	V <sub>DD</sub> = 3 V; V <sub>O</sub> = 0.4 V; see Fig.11	0.7	3.5	_	mA
I <sub>OH</sub>	HIGH level pull-up output	V <sub>DD</sub> = 3 V; V <sub>O</sub> = 2.7 V; see Fig.12	-10	-30	_	μΑ
	source current	V <sub>DD</sub> = 3 V; V <sub>O</sub> = 0 V; see Fig.12	_	-140	-300	μΑ
I <sub>OH1</sub>	HIGH level push-pull output source current	$V_{DD} = 3 \text{ V}; V_{O} = 2.6 \text{ V}; \text{ see Fig.13}$	-0.7	-3.5	_	mA
Real-time	clock 32 kHz oscillator			•		!
g <sub>m</sub>	transconductance	V <sub>i(p-p)</sub> < 50 mV; see Fig.14	2	10	50	μS
δf/f	frequency adjustment	W 17	-0.6 × 10 <sup>-6</sup>	_	+0.6 × 10 <sup>-6</sup>	
C <sub>i</sub>	input capacitance (pin 10)		_	10	_	pF
Co	output capacitance (pin 11)		_	10	_	pF
TONE out	put (see Fig.15; notes 1 and 4)					•
V <sub>HG(RMS)</sub>	HGF voltage (RMS value)		158	181	205	mV
V <sub>LG(RMS)</sub>	LGF voltage (RMS value)		125	142	160	mV
Δf/f	frequency deviation		-0.6	_	0.6	%
$V_{DC}$	DC voltage level		_	0.5V <sub>DD</sub>	_	V
Z <sub>o</sub>	output impedance		_	100	500	Ω
G <sub>v</sub>	pre-emphasis of group		1.5	2.0	2.5	dB
THD	total harmonic distortion	T <sub>amb</sub> = 25 °C; note 5	_	-25	_	dB

## 8-bit microcontroller with DTMF generator, 256 bytes EEPROM and real-time clock

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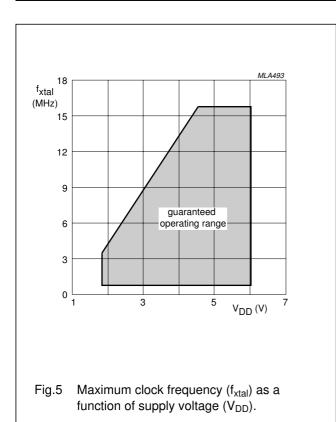
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
EEPROM	(notes 1 and 6)		•		•	
n <sub>cyc</sub>	endurance (erase/write cycles)	note 7	10 <sup>5</sup>	_	_	
t <sub>D(ret)</sub>	data retention		10	_	_	years
Power-on	Power-on-reset					
$\Delta V_{POR}$	Power-on-reset level variation around chosen V <sub>POR</sub>	note 8	-0.5	0	+0.5	V
Oscillator	Oscillator (see Fig. 17)					
g <sub>m</sub> L	LOW transconductance	V <sub>DD</sub> = 5 V	0.2	0.4	1.0	mS
g <sub>mM</sub>	MEDIUM transconductance	V <sub>DD</sub> = 5 V	0.9	1.6	3.2	mS
g <sub>mH</sub>	HIGH transconductance	V <sub>DD</sub> = 5 V	3	4.5	9.0	mS
R <sub>F</sub>	feedback resistor		0.3	1.0	3.0	МΩ

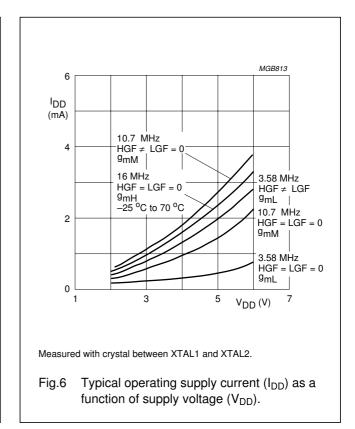
#### **Notes**

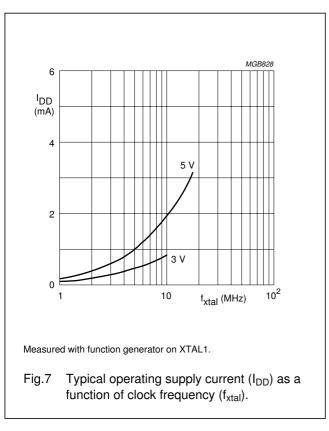
- 1. TONE output; EEPROM erase and write require V<sub>DD</sub> ≥ 2.5 V:
  - a) TONE output requires  $f_{xtal} < 4$  MHz in case DIV3 = 0.
  - b) TONE output requires  $f_{xtal} < 12$  MHz in case DIV3 = 1.
- 2.  $V_{IL} = V_{SS}$ ;  $V_{IH} = V_{DD}$ ; open-drain outputs connected to  $V_{SS}$ ; all other outputs open:
  - a) Maximum values: external clock at XTAL1 and XTAL2 open-circuit.
  - b) Typical values: T<sub>amb</sub> = 25 °C; crystal connected between XTAL1 and XTAL2.
- 3.  $V_{IL} = V_{SS}$ ;  $V_{IH} = V_{DD}$ ; RESET, T1 and CE/ $\overline{T0}$  at  $V_{SS}$ ; crystal connected between XTAL1 and XTAL2; open-drain outputs connected to  $V_{SS}$ ; all other outputs open.
- 4. Values are specified for DTMF frequencies only (CEPT).
- 5. Related to the Low Group Frequency (LGF) component (CEPT).
- 6. After final testing the value of each EEPROM bit is typically logic 1.
- 7. Verified on sampling basis.
- 8. V<sub>POR</sub> is an option chosen by the user. Depending on its value, it may restrict the supply voltage range.

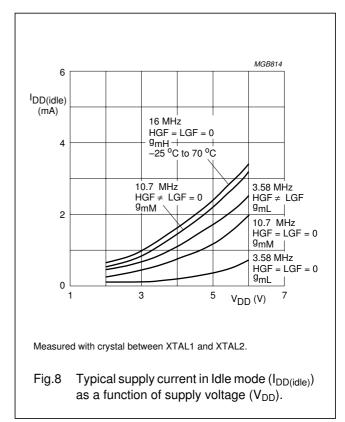
## 8-bit microcontroller with DTMF generator, 256 bytes EEPROM and real-time clock

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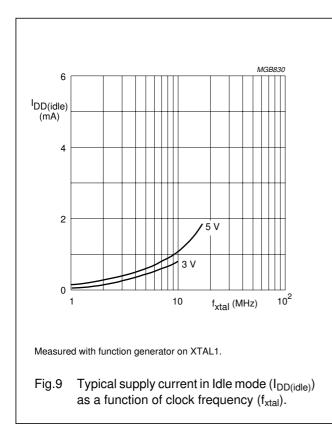


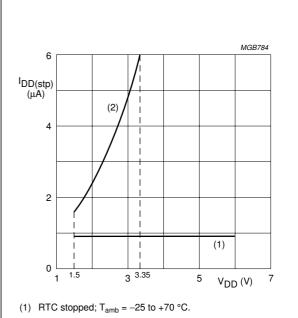




## 8-bit microcontroller with DTMF generator, 256 bytes EEPROM and real-time clock

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(2) RTC running;  $T_{amb} = -25 \text{ to } +70 \text{ }^{\circ}\text{C}$ .

Fig.10 Typical supply current in Stop mode  $(I_{DD(stp)})$  as a function of supply voltage  $(V_{DD})$ .

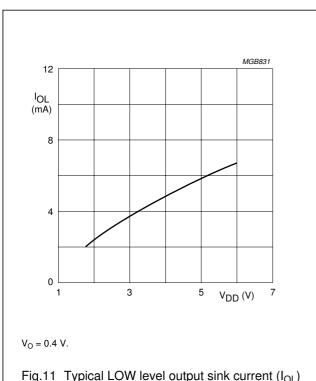


Fig.11 Typical LOW level output sink current ( $I_{OL}$ ) as a function of supply voltage ( $V_{DD}$ ).

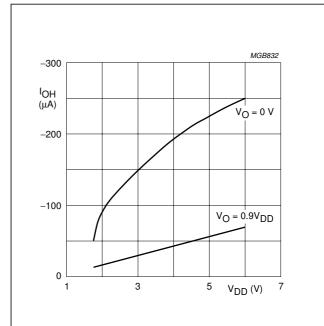


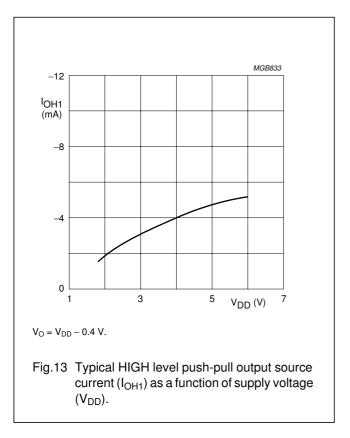
Fig.12 Typical HIGH level pull-up output source current ( $I_{OH}$ ) as a function of supply voltage ( $V_{DD}$ ).

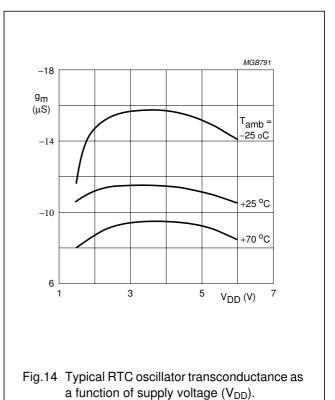
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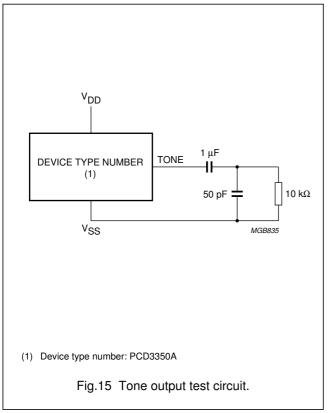
30

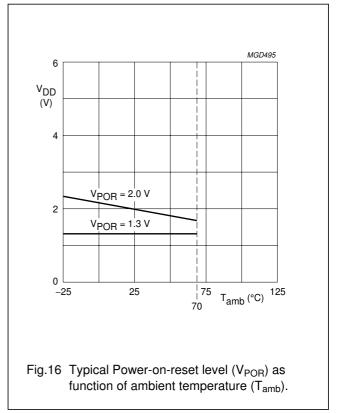
## 8-bit microcontroller with DTMF generator, 256 bytes EEPROM and real-time clock

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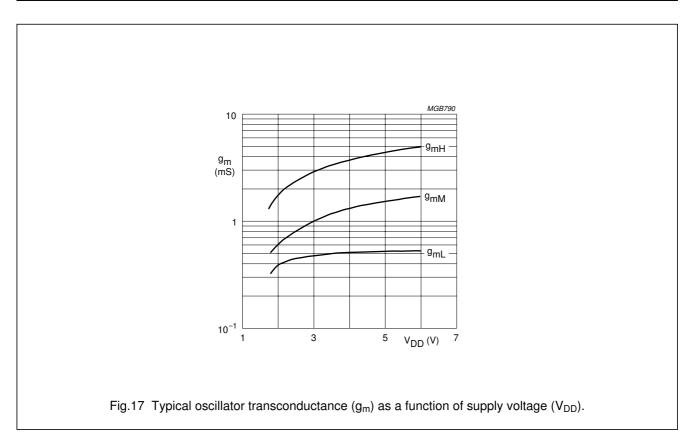


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# 8-bit microcontroller with DTMF generator, 256 bytes EEPROM and real-time clock

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### 19 AC CHARACTERISTICS

 $V_{DD}$  = 1.8 to 6 V;  $V_{SS}$  = 0 V;  $T_{amb}$  = -25 to +70 °C; all voltages with respect to  $V_{SS}$ ; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
t <sub>r</sub>	rise time all outputs	V <sub>DD</sub> = 5 V; T <sub>amb</sub> = 25 °C; C <sub>L</sub> = 50 pF	_	30	_	ns
t <sub>f</sub>	fall time all outputs		_	30	_	ns
f <sub>xtal</sub>	clock frequency	see Fig.5	1	_	16	MHz

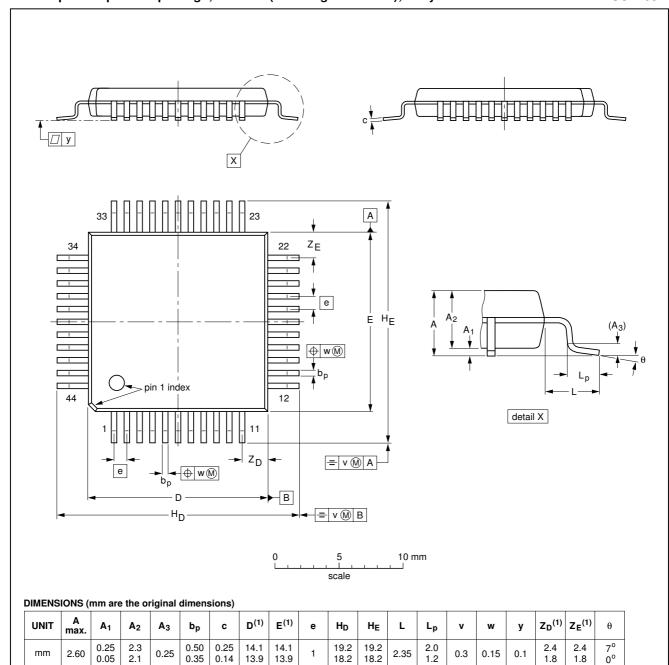
## 8-bit microcontroller with DTMF generator, 256 bytes EEPROM and real-time clock

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### 20 PACKAGE OUTLINE

QFP44: plastic quad flat package; 44 leads (lead length 2.35 mm); body 14 x 14 x 2.2 mm

SOT205-1



#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFERENCES				
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT205-1	133E01A					<del>95-02-04</del> 97-08-01

## 8-bit microcontroller with DTMF generator, 256 bytes EEPROM and real-time clock

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#### 21 SOLDERING

#### 21.1 Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "IC Package Databook" (order code 9398 652 90011).

### 21.2 Reflow soldering

Reflow soldering techniques are suitable for all QFP packages.

The choice of heating method may be influenced by larger plastic QFP packages (44 leads, or more). If infrared or vapour phase heating is used and the large packages are not absolutely dry (less than 0.1% moisture content by weight), vaporization of the small amount of moisture in them can cause cracking of the plastic body. For more information, refer to the Drypack chapter in our "Quality Reference Handbook" (order code 9397 750 00192).

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

### 21.3 Wave soldering

Wave soldering is **not** recommended for QFP packages. This is because of the likelihood of solder bridging due to closely-spaced leads and the possibility of incomplete solder penetration in multi-lead devices.

If wave soldering cannot be avoided, the following conditions must be observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The footprint must be at an angle of 45° to the board direction and must incorporate solder thieves downstream and at the side corners.

Even with these conditions, do not consider wave soldering the following packages: QFP52 (SOT379-1), QFP100 (SOT317-1), QFP100 (SOT317-2), QFP100 (SOT382-1) or QFP160 (SOT322-1).

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

### 21.4 Repairing soldered joints

Fix the component by first soldering two diagonally-opposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

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### 22 DEFINITIONS

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values				
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.				

### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

### 23 LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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